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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/603,781	06/26/2003	Masanari Yokogawa	047297-0136	4070	
22428	7590 11/04/2005	0 11/04/2005		EXAMINER	
FOLEY AND LARDNER LLP SUITE 500			ALEJANDRO MULERO, LUZ L		
3000 K STREET NW WASHINGTON, DC 20007			ART UNIT	PAPER NUMBER	
			1763		

DATE MAILED: 11/04/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

		Application No.	Applicant(s)					
Office Action Summary		10/603,781	YOKOGAWA E	ΓAL.				
		Examiner	Art Unit					
		Luz L. Alejandro	1763	·				
Period fo	The MAILING DATE of this communication apport	pears on the cover she	eet with the correspondence a	address				
· WHIC - Exte after - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPLICATION OF THE MAILING DISTRICT IN THE MAILING THE MAILIN	ATE OF THIS COMN 136(a). In no event, however, i will apply and will expire SIX (i e, cause the application to become	IUNICATION.  may a reply be timely filed  by MONTHS from the mailing date of this one ABANDONED (35 U.S.C. § 133).	•				
Status				•				
1)⊠	Responsive to communication(s) filed on 14 S	September 2005.		·				
,—	•	s action is non-final.						
3)□	Since this application is in condition for allowance except for formal matters, prosecution as to the merits is							
·	closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.							
Di	ion of Olaima		•	•				
-	ion of Claims		•	<u>.</u> .				
4)⊠	Claim(s) 1,2,4,5 and 7 is/are pending in the ap							
	4a) Of the above claim(s) is/are withdra	wn from consideration	n.					
·	Claim(s) is/are allowed.		4,					
6)⊠ Claim(s) <u>1,2,4,5 and 7</u> is/are rejected.								
7)∐	Claim(s) is/are objected to.							
8)[_	Claim(s) are subject to restriction and/o	or election requiremen	nt.	•				
Applicat	ion Papers							
9)[	The specification is objected to by the Examine	er.		• • :				
10) The drawing(s) filed on is/are: a) □ accepted or b) □ objected to by the Examiner.								
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).								
	Replacement drawing sheet(s) including the correct							
11)	The oath or declaration is objected to by the E	xaminer. Note the atta	ached Office Action or form	PTO-152.				
Priority I	under 35 U.S.C. § 119			•				
-	-		C C (110(a) (d) ar (f) :	•				
-	Acknowledgment is made of a claim for foreign	n priority under 35 U.S	5.C. 9 119(a)-(d) or (1).					
a)	☐ All b)☐ Some * c)☐ None of:	ta haya haan raasiya						
	1. Certified copies of the priority document		•					
	<ul><li>2. Certified copies of the priority documen</li><li>3. Copies of the certified copies of the priority</li></ul>		· ·	al Stage				
	3. Copies of the certified copies of the pricapplication from the International Burea			ai Olage				
* (								
* See the attached detailed Office action for a list of the certified copies not received.								
				•				
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Attachmer	nt(s)							
1) Notice of References Cited (PTO-892)  4) Interview Summary (PTO-413)								
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)  3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date  5) Notice of Informal Patent Application (PTO-152)								
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)  Paper No(s)/Mail Date  5) Notice of Informal Patent Application (PTO-152)  6) Other:								

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#### **DETAILED ACTION**

### **Drawings**

The drawings were received on 9/14/05. These drawings are approved.

## Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1-2, 4-5, and 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Saeki et al., U.S. Patent 5,460,684.

Saeki et al. shows the invention substantially as claimed including a semiconductor wafer treatment member having at least a surface formed with a silicon carbide film 3 thereon, comprising a support portion for supporting a semiconductor

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wafer, said support portion being composed of salients with which said semiconductor wafer substantially comes into contact; and depressions formed with the silicon carbide film to provide a coverage area between said salients, said salients being formed with a surface roughness of 0.1 to 1.5 microns (see fig. 1 and its description).

Saeki et al. does not expressly disclose the salients being formed with a surface roughness of 0.05 to 1.3 microns, wherein said coverage area has a ratio of 20 to 90% to a total area of said depressions, the depressions having faces with a roughness of 3 microns or more when measured for a length of 300 microns, and the top surfaces of the salients and said surfaces of the depression have boundary portions in the form of curves. With respect to the surface roughness of the salients, a prima facie case of obviousness exists because overlapping ranges establish a prima facie case of obviousness. Regarding the coverage area ratio, the roughness of the depressions, and the boundaries between the salients and depression, it would have been obvious to one of ordinary skill in the art at the time the invention was made to determine through routine experimentation the optimum coverage ratio and surface roughness based upon a variety of factors including the desired degree of adhesion to the wafer, for example, and such limitation would not lend patentability to the instant invention absent a showing of unexpected results. Concerning the shape of the boundaries, the configuration of the claimed boundaries is a matter of choice which a person of ordinary skill in the art would have found obvious absent persuasive evidence that the claimed boundary shape is significant.

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Claims 1-2, 4-5, and 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Toya et al., U.S. Patent 5,200,157 in view of Saeki et al., U.S. Patent 5,460,684.

Toya et al. shows the invention substantially as claimed including a semiconductor wafer treatment member having at least a surface formed with a silicon carbide film 2 thereon, comprising a support portion for supporting a semiconductor wafer, said support portion being composed of salients with which said semiconductor wafer substantially comes into contact; and depressions formed with the silicon carbide film to provide a coverage area between said salients, said salients being formed with a surface roughness of 12.5 microns (see fig. 3 and its description).

Toya et al. does not expressly disclose a silicon carbide film, the salients being formed with a surface roughness of 0.05 to 1.3 microns, wherein said coverage area has a ratio of 20 to 90% to a total area of said depressions, and the top surfaces of the salients and said surfaces of the depression have boundary portions in the form of curves.

Saeki et al. discloses a support with a silicon carbide film 3 thereon (see fig. 1 and its description). In view of this disclosure, it would have been obvious to one of ordinary skill in the art at the time the invention was made to modify the apparatus of Toya et al. so as to include a silicon carbide film as shown in Saeki et al. because this is shown to be a suitable wafer support structure.

Regarding the coverage area ratio, the roughness of the salients, and the boundaries between the salients and depression, it would have been obvious to one of

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ordinary skill in the art at the time the invention was made to determine through routine experimentation the optimum coverage ratio and surface roughness based upon a variety of factors including the desired degree of adhesion to the wafer, for example, and such limitation would not lend patentability to the instant invention absent a showing of unexpected results. Concerning the shape of the boundaries, the configuration of the claimed boundaries is a matter of choice which a person of ordinary skill in the art would have found obvious absent persuasive evidence that the claimed boundary shape is significant.

Claims 1-2, 4-5, and 7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Waldhauer et al., US 2004/0060512.

Waldhauer et al. shows the invention substantially as claimed including a semiconductor wafer treatment member having at least a surface formed with a silicon carbide film 134 thereon, comprising a support portion for supporting a semiconductor wafer, said support portion being composed of salients with which said semiconductor wafer substantially comes into contact; and depressions formed with the silicon carbide film to provide a coverage area between said salients, said salients being formed with a surface roughness of 4-16 microinches which equates to 0.106-0.4064 microns (see fig. 3 and its description).

Waldhauer et al. does not expressly disclose the salients being formed with a surface roughness of 0.05 to 1.3 microns, wherein said coverage area has a ratio of 20 to 90% to a total area of said depressions, the depressions having a surface roughness

of 3 microns or more when measured for a length of 300 microns, and the top surfaces of the salients and said surfaces of the depression have boundary portions in the form of curves. With respect to the surface roughness of the salients, a prima facie case of obviousness exists because overlapping ranges establish a prima facie case of obviousness.

Regarding the coverage area ratio, the roughness of the salients, and the boundaries between the salients and depression, it would have been obvious to one of ordinary skill in the art at the time the invention was made to determine through routine experimentation the optimum coverage ratio and surface roughness based upon a variety of factors including the desired degree of adhesion to the wafer, for example, and such limitation would not lend patentability to the instant invention absent a showing of unexpected results. Concerning the shape of the boundaries, the configuration of the claimed boundaries is a matter of choice which a person of ordinary skill in the art would have found obvious absent persuasive evidence that the claimed boundary shape is significant.

## Response to Arguments

Applicant's arguments filed 9/14/05 have been fully considered but they are not persuasive. Applicant argues that the references fail to disclose the claimed surface roughnesses. However, it would have been obvious to one of ordinary skill in the art at the time the invention was made to determine through routine experimentation the optimum coverage ratio and surface roughness based upon a variety of factors

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including the desired degree of adhesion to the wafer, for example, and such limitation would not lend patentability to the instant invention absent a showing of unexpected results. No unexpected results have been shown with respect to the salients and depressions.

#### Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Luz L. Alejandro whose telephone number is 571-272-1430. The examiner can normally be reached on Monday to Thursday from 7:30 to 6:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Parviz Hassanzadeh can be reached on 571-272-1435. The fax phone

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number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov: Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Luz L. Alejandro Primary Examiner Art Unit 1763

November 1, 2005